Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

- 1-24. (Canceled).
- 25. (Currently Amended) A flexible printed wiring board comprising:
 - a metal film before patterning,
 - a resin coating on said metal film,
 - an opening formed in said resin coating, and

a metal bump located in said opening, connected at its bottom face to said metal film and having a height greater than the thickness of said resin coating,

wherein said resin coating is removed at the portion located at a top face of said metal bump and the top face of said metal bump is exposed from the surface of said resin coating-, and

said resin coating has a first resin coating made of rigid resin close contacted to said metal film, and a second resin coating having adhesive close contacted to said first resin coating.

- 26. (Canceled).
- 27. (Previously Presented) A flexible printed wiring board comprising:
 - a metal film,
 - a resin coating on said metal film,
 - an opening formed in said resin coating, and
- a metal bump located in said opening, connected at its bottom face to said metal film and having a height greater than the thickness of said resin coating.

wherein said resin coating is removed at the portion located at a top face of said metal bump and the top face of said metal bump is exposed from the surface of said resin coating,

wherein said resin coating have a first resin coating made of rigid resin close contacted to said metal film, and a second resin coating having adhesive close contacted to said first resin coating, and said second resin coating is exposed.

- 28. (Previously Presented) The flexible printed wiring board according to claim 27 wherein said metal film is patterned in a predetermined form.
- 29. (Previously Presented) The flexible printed wiring board according to claim 28, wherein an electric device is mounted on said flexible printed wiring board and a bonding pad of said electric device is connected with the front face of said metal bump.